Descrição do Produto

A pasta BEST-solder (Tin) é a melhor opção para reballing IC.
MELHOR marca original,
Qualidade Verificada

Aplicação: pode ser usado para laptop / computador / telefone celular / eletrodomésticos SMD IC e BGA IC reparação, ferramentas para chip-levelreparação e linha de fabricação de eletrônicos.

Parâmetro de tecnologia

Modelo	BEST-75

C a t e o s 9 ç ã p d a t a g a ; 3 % / c o b r e : , 7 %

2 0 6 - 2 2 e f C s ã o :

Tamanho de partícula de pó de estanho:

25-45/μm

Formas de pó de estanho: esférico

Teor de metal: 82,5±1%

Temperatura de refrigeração: 5~10°C

NW

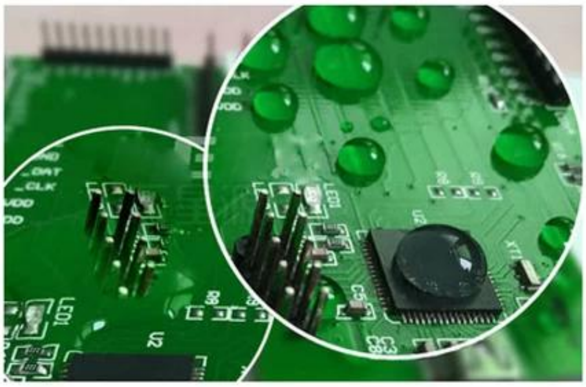
5g/pc


SOLDER PASTE
Lead-free High temperature
BEST 倍思特
SOLDER PASTE
MODEL: BST-705
Alloy: Sn99/Ag0.3/Cu0.7
Shelf Life: 6 months
Net Weight: 500g
CE
PRECISION ELECTRONIC REPAIR
BEST 倍思特
SOLDER PASTE
BGA植锡膏
Low residue 低残留物
Cold storage 低温冷藏
Mid-melting point 中温熔点
Even solder joints 焊点均匀
CE
MADE IN CHINA
500g
Low residue / Rapid welding / lead free / Solder spot bright /Ag

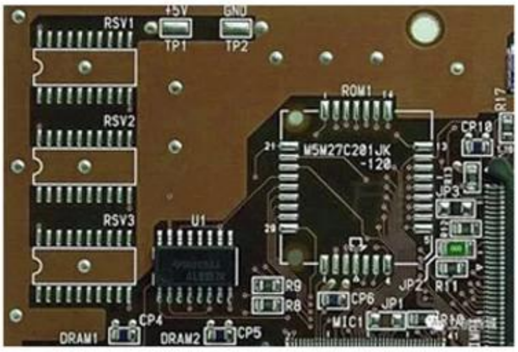
Product Usage

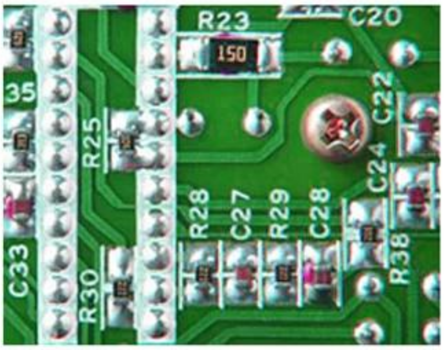
MODEL	BST-705
SHELF LIFE	6 months
INGREDIENT	Sn99/Ag0.3/Cu0.7
WEIGHT	500g
MELTING POINT	217℃

Having a large insulation resistance does not corrode the PCB, and the requirements for no-cleaning can be achieved.



High impedance, full and bright solder, low residue





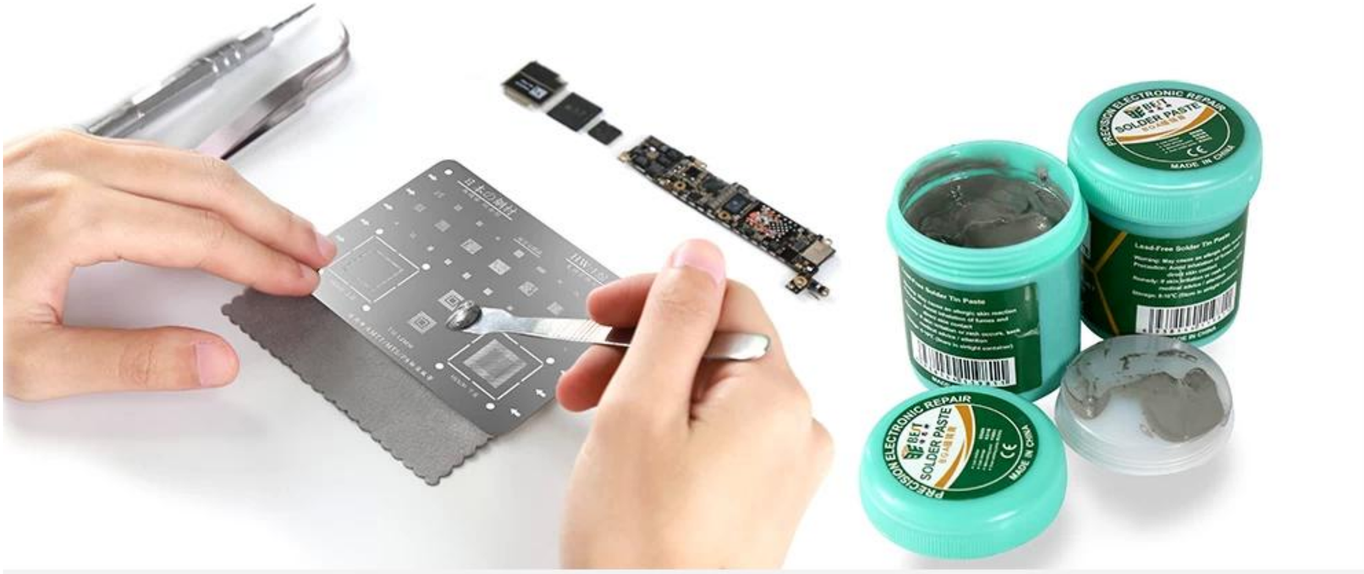
PRODUCT INFORMATION

Welding requirements for a wide range of products

TESTING EFFECT

UNIFORM SOLDER JOINT

MEDIUM TEMPERATURE MELTING POINT



PRODUCT SIZE


PRECISION ELECTRONIC REPAIR
BEST
SOLDER PASTE
BGA锡膏
CE
MADE IN CHINA
Lead-Free Solder Tin Paste
Warning: May cause an allergic skin reaction
Precaution: Avoid inhalation of fumes and direct skin contact
Remedy: If skin irritation or rash occurs, seek medical advice / attention
Storage: 0-10°C (Store in airtight container)